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S/N 10/043898

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

UEDA ET AL.

Examiner:

D. NGUYEN

10/043898

Group Art Unit:

2814

Serial No.: Filed:

JANUARY 11, 2002

Docket No .:

10921.110US01

Title:

SEMICONDUCTOR DEVICE WITH COATED SEMICONDUCTOR CHIP

(AS AMENDED)

CERTIFICATE UNDER 37 CFR 1.6(d):

The undersigned hereby certifies that this correspondence is being transmitted via facsimile to: Commissioney for Patents, Attention: Examiner Dilinh P. Nguyen, P.O. Box 1450, Alexandria, NA 22313-1450 on October

2004.

msden Name: Shep

<u>AMENDMENT</u>

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Commissioner:

In response to the Office Action dated June 2, 2004, with the time for response extended with a one-month extension of time from September 2, 2004 to October 2, 2004, please amend the above-referenced patent application as indicated herein.

Amendments to the Claims are reflected in the listing of claims beginning on page 2 of this paper.

Remarks begin on page 4 of this paper.